

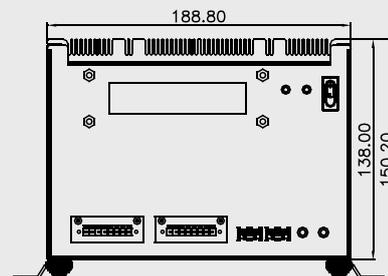
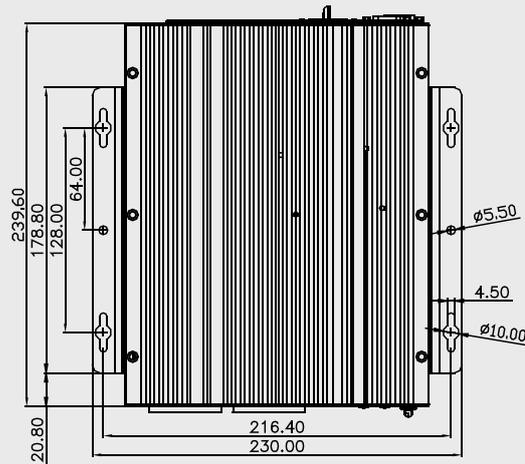
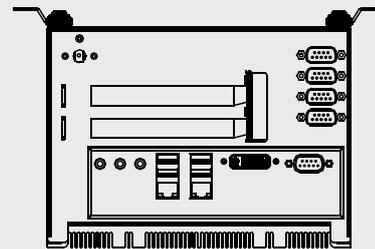
### Feature :

1. Special design for ODM/OEM projects.
2. Silent, dust-free & energy-efficient operation.
3. Simple assembling and easy system integration.
4. Compatible with different types of Mini-ITX MB.
5. Innovative thermal cooling-combination of thermal pads and copper thermal blacks.



### Specifications :

Front Panel	<ul style="list-style-type: none"> <li>● Power switch x 1</li> <li>● HDD LED x 1</li> <li>● Audio IN/OUT x 1</li> <li>● LCM module x 1</li> <li>● Terminal Block x 2</li> <li>● Power LED x 1</li> <li>● USB Port x 1</li> </ul>
Back Panel	<ul style="list-style-type: none"> <li>● Standard I/O shield (not included).</li> <li>● Expansion PCI/PCI-E slot x 2</li> <li>● DC Jack x 1</li> <li>● Extra Serial Port x 4</li> </ul>
Internal Structure	<ul style="list-style-type: none"> <li>● Thermal pads / Copper thermal block combination are positioned at the top of the CPU and chipset and transfer the heat to the Aluminum-made heat sink surface of the top cover to two sides of the chassis. (Passive cooling chassis could only dissipate CPU with less than 35 Watts TDP.)</li> <li>● Standard memory height.</li> <li>● 3.5" HDD x 1</li> </ul>
Dimension ( WxDxH )	7.43 x 9.43 x 5.43 inch ( 188.8 x 239.6 x 138.0 mm )
Material	Zine-Fe Alloy Sheet.
Surface	Black wet paint with texture coat.
Colour	Black. Customizable colour.



UNIT:mm

### Power Solutions :

Internal Power Supply	External AC adapter
C7 (80W) DC Power Board	60 Watts (12V) or 80 Watts (12V)